

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Philippe Blanchard	06/24/2007
RECEIVING PARTY DATA	
Name:	Qimonda AG
Street Address:	Gustav-Heinemann-Ring 212
City:	Munich
State/Country:	GERMANY
Postal Code:	81739
Name:	ALTIS Semiconductor
Street Address:	SNC 224 Bld. John Kennedy
City:	Corbeil Essonnes Cedex
State/Country:	FRANCE
Postal Code:	ZIP 3 P 91105
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	11784206
CORRESPONDENCE DATA	
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ATTORNEY DOCKET NUMBER:	2007 VJ 31878 US (QIM-VJ)

CH \$40.00 11784206

PATENT

500306057

REEL: 019498 FRAME: 0352

NAME OF SUBMITTER:

Julie Russell

Total Attachments: 2

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ASSIGNMENT

For good and valuable consideration, I, **Philippe Blanchard**, residing at 11, sentier de la Grille, 91490 Moigny sur Ecole, France, a citizen of France;

hereby sell, assign, and transfer to **Qimonda AG**, a corporation organized and existing under the laws of Germany, having its principal place of business at Gustav-Heinemann-Ring 212, 81739 Munich, Germany and **ALTIS Semiconductor**, a corporation organized and existing under the laws of France, having its principal place of business at SNC 224 Bld. John Kennedy, ZIP 31 P 91105 Corbeil Essonnes Cedex, France;

hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned concurrently herewithin, and is entitled:

Method of Manufacturing an Integrated Circuit, an Integrated Circuit, and a Memory Module

and in and to said application and all divisional, continuing substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

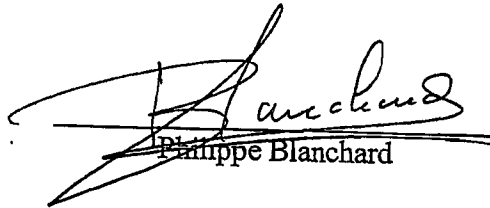
Agree that Assignee may apply for and receive Letters Patent for said improvements in its own name, and that, when requested, without charge to but at the expense of said Assignee, their successors, assigns, and legal representatives to carry out in good faith the intent and purpose of this agreement, the undersigned will execute all divisional, continuing substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors,

assigns, and representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns, or representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Date:

24 June 2007


Philippe Blanchard